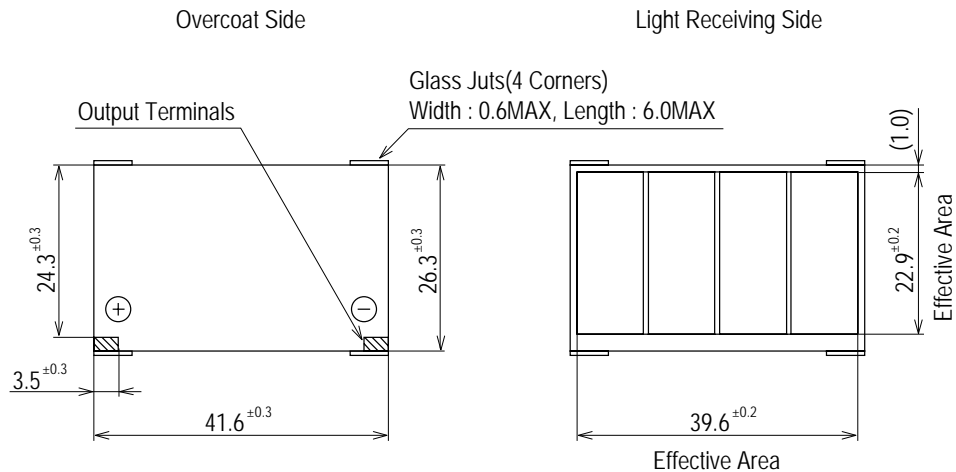


AM-1454

Package Dimensions (unit : mm)


Note: Glass Substrate Thickness : 1.1mm
 Module Thickness : 1.3mm max
 Accepts normal soldering for bending.

Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Open Circuit Voltage	Voc	FL 200Lx		2.4		V
Short Circuit Current	Isc	FL 200Lx		35.0		μA
Operating Voltage & Operating Current	Iope	FL 200Lx, Vope=1.5V	21.0	31.0		μA
Operating Temperature	Topr		-5 to +40			°C
Storage Temperature	Tstg		-20 to +70			°C
Working Illuminance Range		to 1000Lx				

FL: White Fluorescent Light

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